

Soldering & Desoldering



No Clean Solder

Detailed product specifications are available on: us. 100y. com. tw

Part No.	Product No.	Description	Melting Temp ℃	Alloy proportion	Weight/R	Wire dia
7625	0.8mm ∮ /63%/0.5kg	No Clean, Solder	183℃	Sn63Pb37	0.5kg/R	0.8mm
5660	0.8mm ∮ /63%/1kg	No Clean, Solder	183℃	Sn63Pb37	1kg/R	0.8mm
2065	1.0mm ∮ /63%/0.5kg	No Clean, Solder	183℃	Sn63Pb37	0.5kg/R	1.0mm
2064	1.0mm ∮ /63%/1kg	No Clean, Solder	183℃	Sn63/Pb37	1kg/R	1.0mm



Part No.	Product No.	Description	Melting Temp ℃	Alloy proportion	Weight/R	Wire dia	
29122	1.0mm ∮ /60%/1kg	No Clean, Solder	183℃	Sn60Pb40	1kg	1.0mm	

Silver Solder Wire

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Composition	Composition	Flux%	Specific gravity	Application	Dia.	Packages
Solder Dispenser (Small Pack of Wire Solder)	SN: 40%~63%	2.0~2.2	8.4~9.2	For student's field-study DIY products, and electrical equipment repairing	0.8m/m 1.0m/m 1.2m/m	15~20gm

Part No.	Product No.	Description	Alloy proportion	Melting	Wire dia.	Weight/R
3112	SD-11	Silver Solder Wire Pen	60-37.5-2.5	234~244℃	0.8mm	About 5m



NON-HALIDE WASH FREE SOLDER (RMA EQUIVALENT)

The SOLPET RMA series is high capacity solder with rosion that was developed to be wash free. We improved its reliability to be ecellent under the severest conditions of high temperature and humidity. It sets a new standard of high temperature and humidity. It sets a new standard of reliability.

Solder with rosin that does not contain thus making the copper surface active. This allows wash free soldering of PCBs Improves the reliability of products such as computers, telephones, stereos and tools by minimal residual contamination

Part No.	Product No.	Manufacturer	Description	Alloy proportion	Melting	Wire dia.	Weight/R
14660	SE-06003-RMA	Goot	Goot_Silver RMA Wash-Free Solder Wire	Sn60%	183℃	0.3mm	100g
11043	SE-26008RMA	Goot	Silver Solder Wire	60%	183℃	0.8mm	200g



Part No.	Product No.	Description	Alloy proportion	Melting	Wire dia.	Weight/R
11556	SE-200G08	Silver Solder Wire	25%	194℃	0.8mm	200g



POWER SOLDER

Recently more solid soldering is required by manufactures power solder is the answer with its excellent capacity for operation efficiency and excellent anti-crack strength caused by the repeat of the heating and cooling of electronic components

FEATURES

Compared with eutectic solder, the rate of solder crack activator is less than 1/8. Mixture of high perforxance activator resulted excellent wetting too.

The highest quality materials are used to minimize odor.

Part No.	Product No.	Manufacturer	Description	Alloy proportion	Melting	Wire dia.	Weight/R
11044	SE-26208PL	Goot	Goot_Silver Solder Wire	Exclusive	189 ℃	0.8 mm	200g



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Taiwan: 886-3-5753170

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Part No.	Product No.	Manufacturer	Description	Alloy proportion	Melting	Wire dia.	Weight/R
4395	SE-2AG08	Goot	Silver Solder Wire	Sn60-Pb37.5-Ag2.5	194℃	0.8mm	200g

- We provide a wide range of products to development and maintenance engineers in all type of business
- If you cannot find the components you want on the catalogue, please call us.

Centenary Materials



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